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# 6388

### Thermal Via Fill Pd/Ag Conductor

6388 is a Pd/Ag conductor designed for filling or plugging through-holes in 96% alumina substrates. Its target applications include substrates for chip size package, power amplifier module, and high-density circuit.

#### **Major Features of 6388**

- \* High thermal conductivity.
- \* No shrinkage away from side walls.
- \* Possible cost reduction compared with Aln substrate.
- \* Designed for small via.
- \* Prints easily with stencils (one shot).

#### **Composition Properties**

Solids Weight (%) @1050°C 92.0-94.0% Viscosity 200-400 Pa.s. (Brookfield HBT, Utility Cup and Spindle, 10rpm25°C) Sheet Resistivity (on 96% alumina substrate)  $< 15.0m\Omega/\Box /15\mu m$ 

Thinner

6388 is optimized for screen printing and thinning is not recommended.

#### **Recommended Processing Procedures**

Storage

6388 should be stored at room temperature (5-30°C) in a clean environment.

Note: 6388 should be thoroughly mixed prior to use. Jar rolling is not recommended. It causes changes in the paste rheology. Shelf Life

6388 has a shelf life of six (6) months when sealed and stored at room temperature  $(5-30^{\circ}C)$ .

#### **Recommended Processing**

The recommended processing involves:

- 1. Printing by stencil.
- 2. Drying.
- 3. Firing.
- 4. Refiring.
- 5. Planalization or grinding.
- 6. Top conductor.

Printing

6388 prints easily with stencils. The recommended stencil conditions are:

Stencil Thickness: 150µm

Formation: Low cost etching type

Via Size: > 100µm

Note: Prior to use, 6388 should be thoroughly mixed with a clean spatula. Abrupt mixing should be avoided, as it causes excess of air trapped inside the paste. Printing should be carried out in a clean and well-ventilated room.

To obtain optimal printing results, 6388 should be stored at 20-23°C prior to printing.

Drying

After leveling in a clean room for 5-10 minutes, the printed 6388 should be dried at 120°C for 10 minutes in a well-ventilated oven or belt dryer.

Firing

6388 is designed be fired for 30 minutes in total at 850°C peak temperature.

Note: Firing should be carried out in a well-ventilated conveyor belt furnace. Be aware of possible inlet of organic solvent vapor from outside the furnace. Ensure that the inlet air used does not contain any dry

#### impurities. Due to the required balance of airflow, the environment inside the furnace becomes oxidized. Prevention of the exhaustion gas from entering into other rooms should be enforced.

Number of refirings required Three (3) to four (4) refirings are required. Recommended Planalization Processing

1. Rough scrub with #320 sandpaper or buff roller or ceramic roller.

2. Fine scrub with #800-1000 sandpaper or buff roller or ceramic roller.

Expansion upon firing (%)

Percentage expansion upon firings is shown below:

Number for firings	Expansion (%)
0 (Dried)	100%
1	112%
2	108%
3	107%
4	105%

### Safety and Handling

This product contains organic solvent and materials. The following precautions should be exercised when handling 6388:

- \* Use with adequate ventilation.
- \* Avoid prolonged contact with skin
- \* Avoid prolonged breathing of vapor
- \* If contact with skin occurs, wash affected area immediately with soap and water.
- \* Dangerous if swallowed do not consume.
- \* Ensure that no metal impurities and contaminants on the printing equipment.
- \* Refer to MSDS for more details.

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